STFH13N60M2



N-channel 600 V, 0.35 Ω typ., 11 A MDmesh[™] M2 Power MOSFET in a TO-220FP wide creepage package

Datasheet - production data



Order code	er code V _{DS} R _{DS(on)} max		ΙD
STFH13N60M2	600 V	0.38 Ω	11 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected
- Wide creepage distance of 4.25 mm between the pins

Applications

• Switching applications

Description

This device is an N-channel Power MOSFET developed using MDmesh[™] M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

The TO-220FP wide creepage package provides increased surface insulation for Power MOSFETs to prevent failure due to arcing, which can occur in polluted environments.

TO-220FP wide creepage	

Figure 1: Internal schematic diagram

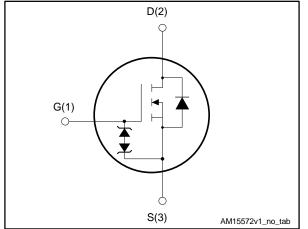


Table 1: Device summary

Order code	Marking	Package	Packaging
STFH13N60M2	13N60M2	TO-220FP wide creepage	Tube

DocID029304 Rev 2

1/12

This is information on a product in full production.

Contents

Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	8
4	Packag	e mechanical data	9
	4.1	TO-220FP wide creepage package information	9
5	Revisio	n history	11



1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	± 25	V
ID	Drain current (continuous) at $T_C = 25 \text{ °C}$	11 ⁽¹⁾	А
ID	Drain current (continuous) at Tc = 100 °C	7 ⁽¹⁾	А
I _{DM} ⁽²⁾	Drain current (pulsed)	44	А
P _{TOT}	Total dissipation at $T_c = 25 \ ^{\circ}C$	25	W
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_c = 25$ °C)	2500	V
dv/dt (3)	Peak diode recovery voltage slope	15	V/ns
dv/dt (4)	MOSFET dv/dt ruggedness	50	v/ns
T _{stg}	Storage temperature range - 55 to 150		°C
Tj	Operating junction temperature range	- 55 10 150	

Notes:

⁽¹⁾Limited by maximum junction temperature.

⁽²⁾Pulse width limited by safe operating area.

 $^{(3)}I_{SD} \leq$ 11 A, di/dt \leq 400 A/µs; V_DS(peak < V(BR)DSS, V_DD = 400 V $^{(4)}V_{DS} \leq$ 480 V

Table 3: Thermal data

Symbol	Parameter		Unit
R _{thj-case}	Thermal resistance junction-case max	5	°C/W
Rthj-amb	Thermal resistance junction-ambient max		°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T_{jmax})	2.8	А
Eas	Single pulse avalanche energy (starting $T_j = 25^{\circ}C$, $I_D = I_{AR}$; $V_{DD} = 50 \text{ V}$)	125	mJ



2 **Electrical characteristics**

(Tc = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	600			V
	Zero gate voltage	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
IDSS	IDSS drain current	$V_{DS} = 600 \text{ V}, \text{ , } V_{GS} = 0 \text{ V},$ $T_{C} = 125 \text{ °C}^{(1)}$			100	μA
Igss	Gate-body leakage current	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
V _{GS(th)}	Gate threshold voltage	V_{DS} = V_{GS} , I_D = 250 μ A	2	3	4	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$		0.35	0.38	Ω

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	580	-	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	32	-	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V	-	1.1	-	pF
C _{oss eq.} (1)	Equivalent output capacitance	V_{DS} = 0 to 480 V, V_{GS} = 0 V	-	120	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz open drain	-	6.6	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 11 A,	-	17	-	nC
Q_{gs}	Gate-source charge	V _{GS} = 10 V (see <i>Figure 15: "Test</i>	-	2.5	-	nC
Q_{gd}	Gate-drain charge	circuit for gate charge behavior")	-	9	-	nC

Table 6: Dynamic

Notes:

 $^{(1)}C_{\text{oss eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}.

Table 7. Switching times						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 300 V, I _D = 5.5 A,	-	11	-	ns
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14: "Test circuit for resistive	-	10	-	ns
t _{d(off)}	Turn-off delay time	load switching times" and Figure	-	41	-	ns
t _f	Fall time	19: "Switching time waveform")	-	9.5	-	ns

Table	7:	Switching	times
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Electrical characteristics

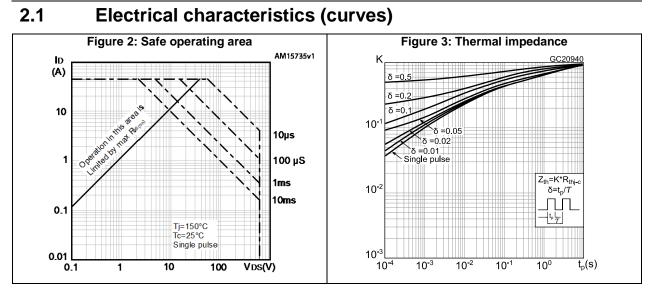
Table 8: Source drain diode									
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit			
Isd	Source-drain current		-		11	А			
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		44	А			
Vsd ⁽²⁾	Forward on voltage	I _{SD} = 11 A, V _{GS} = 0 V	-		1.6	V			
trr	Reverse recovery time		-	297		ns			
Qrr	Reverse recovery charge	I_{SD} = 11 A, di/dt = 100 A/µs, V_{DD} = 60 V (see <i>Figure 16: "Test</i> <i>circuit for inductive load switching</i>	-	2.8		μC			
I _{RRM}	Reverse recovery current	and diode recovery times")	-	18.5		А			
trr	Reverse recovery time	I _{SD} = 11 A, di/dt = 100 A/µs,	-	394		ns			
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 \text{ °C}, \text{ (see Figure 16: "Test circuit for } $	-	3.8		μC			
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	19		А			

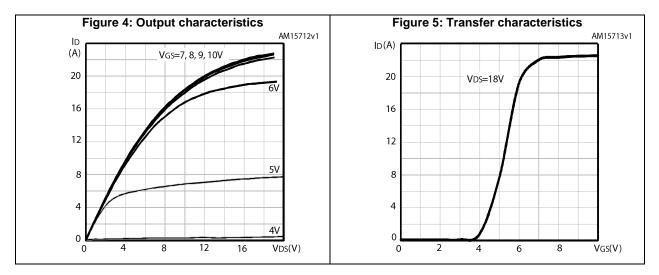
Notes:

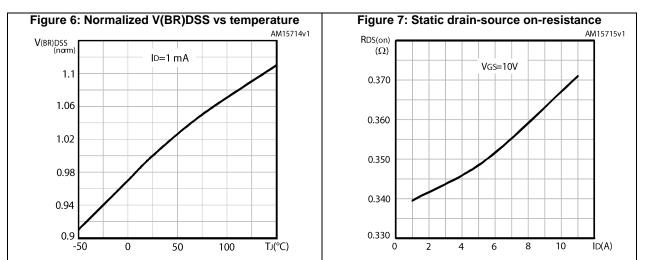
⁽¹⁾Pulse width limited by safe operating area.

 $^{(2)}\text{Pulsed:}$ pulse duration = 300 µs, duty cycle 1.5%.







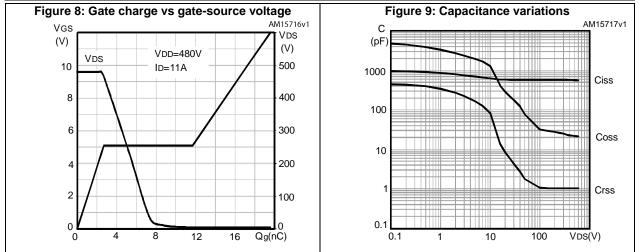


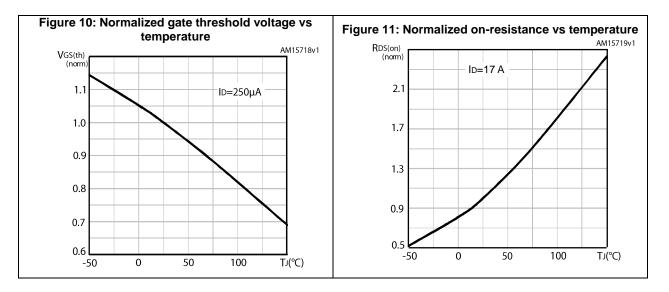


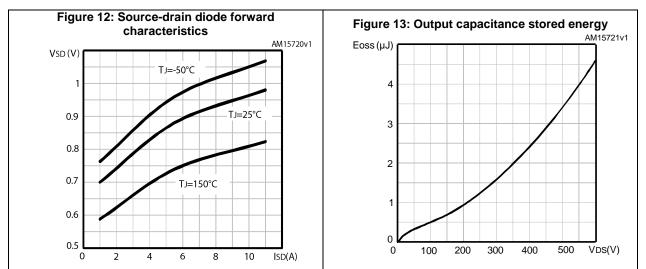
STFH13N60M2

57

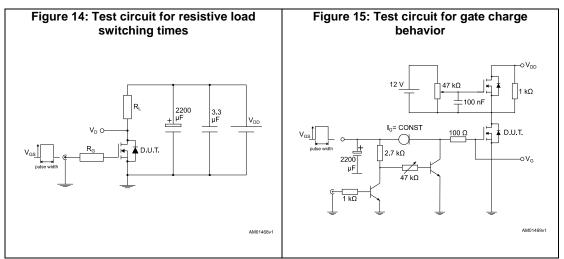
Electrical characteristics

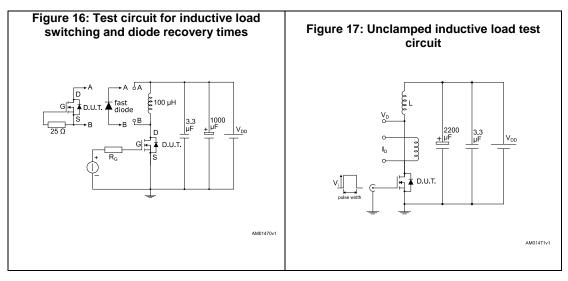


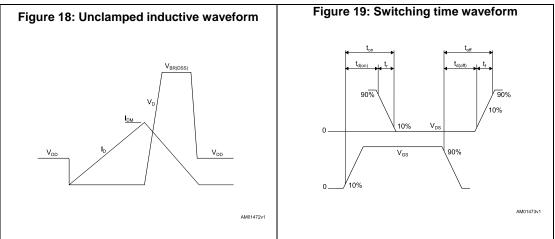




3 Test circuits









4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-220FP wide creepage package information

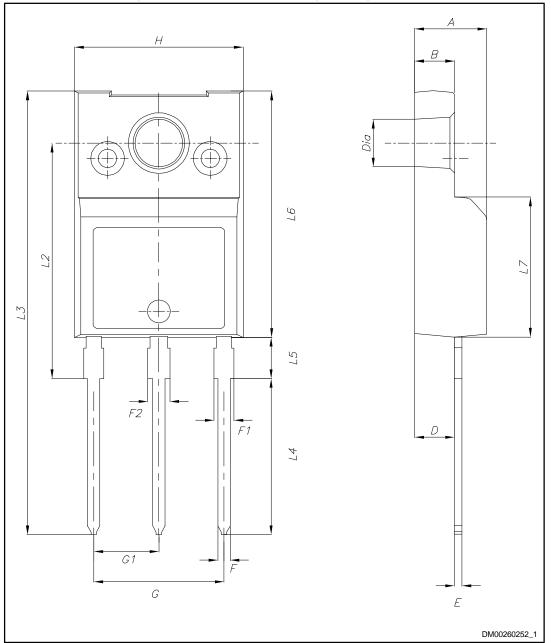


Figure 20: TO-220FP wide creepage package outline



Package mechanical data

STFH13N60M2

Table 9: TO-220FP wide creepage package mechanical data						
Dim.	mm					
Dim.	Min.	Тур.	Max.			
А	4.60	4.70	4.80			
В	2.50	2.60	2.70			
D	2.49	2.59	2.69			
E	0.46		0.59			
F	0.76		0.89			
F1	0.96		1.25			
F2	1.11		1.40			
G	8.40	8.50	8.60			
G1	4.15	4.25	4.35			
Н	10.90	11.00	11.10			
L2	15.25	15.40	15.55			
L3	28.70	29.00	29.30			
L4	10.00	10.20	10.40			
L5	2.55	2.70	2.85			
L6	16.00	16.10	16.20			
L7	9.05	9.15	9.25			
Dia	3.00	3.10	3.20			



5 Revision history

Table 10: Document revision history

Date	Revision	Changes
12-May-2016	1	Initial release
10-Jun-2016	2	Document status promoted from preliminary to production data.



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